

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	269519	metal near (layer film)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/04 14:30
L2	5	1 and (single near grain near size)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/04 15:04
L3	27882	1 and interconnect	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/04 15:44
L4	857	3 and dissimilar	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/04 15:10
L5	2	4 and (single near grain)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/04 15:12
L6	18688	dissimilar near (metal\$1 element\$1 material\$1 conduct\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/04 15:29
L7	25	6 and (single near grain)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/04 15:30
L8	292530	(different dissimilar) near (metal\$1 element\$1 material\$1 conduct\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/04 15:29

L9	273842	8 not 6	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/04 15:29
L10	216	9 and (single near grain)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/04 15:46
L11	27	10 and interconnect	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/04 15:44
L12	209119	plate\$1 near metal\$1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/04 15:44
L13	19518	12 and (wiring interconnect)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/04 15:45
L14	1991	13 and 8	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/04 15:45
L15	3	14 and (single near grain)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/04 15:45
L16	2113	(single near grain)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/04 15:47
L17	157	metal with (single near grain)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/04 15:47